

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		原始版本	PEILEI 06.05.26	
△		增加料号.更改图号	xushiyong 07.02.05	

NOTES:

MATERIAL:

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE T=0.35mm (C5100).
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD: COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

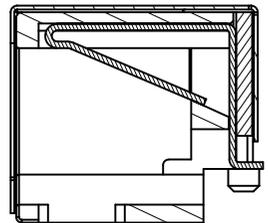
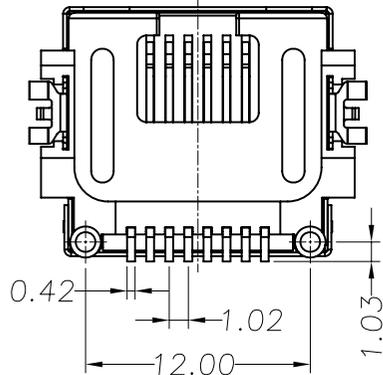
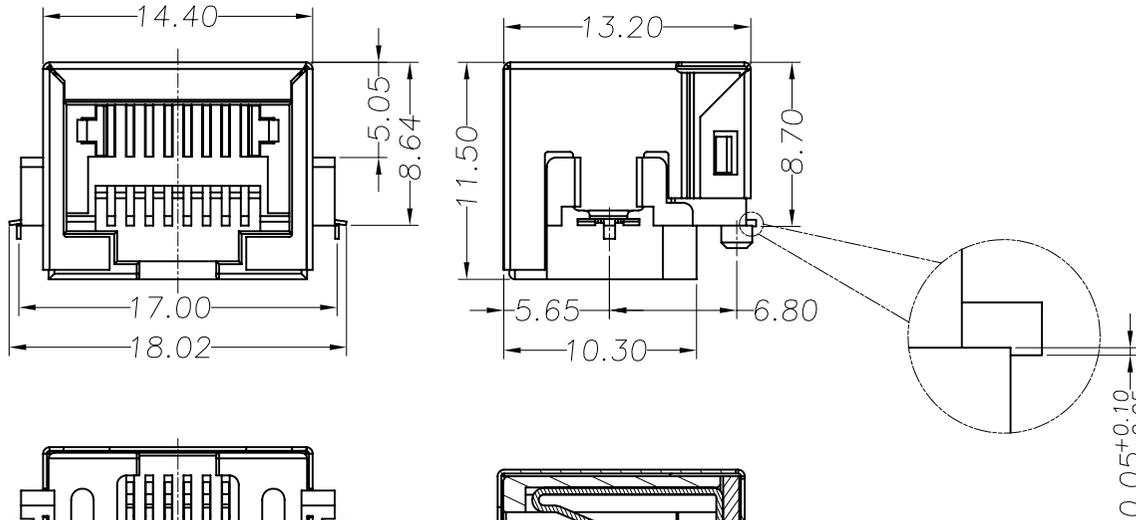
- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

- 1.STORAGE : -40°C TO +85°C.
 2. OPERATION : 0°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.



△ PART NUMBER:

SMT-0388XX0X

SMT SERIES PCB JACK
(SMT系列PCB接口)

SHIELD (屏蔽壳):

- 1-W/O SHIELD (非屏)
- 3-W/ SHIELD (屏蔽)
- POSITIONS (金针位置):
- 4-4POSITIONS (4P) .6-6POSITIONS (6P)
- 8-8POSITIONS (8P) .0-10POSITIONS (10P)

CONTACTS (金针根数):

- 2-2CONTACTS (2C) .4-4CONTACTS (4C) .6-6CONTACTS (6C)
- 8-8CONTACTS (8C) .0-10CONTACTS (10C)

PLASTIC (塑料):

- 1-PBT.2-NYLON66 (尼龙66) .3-NYLON46 (尼龙46)

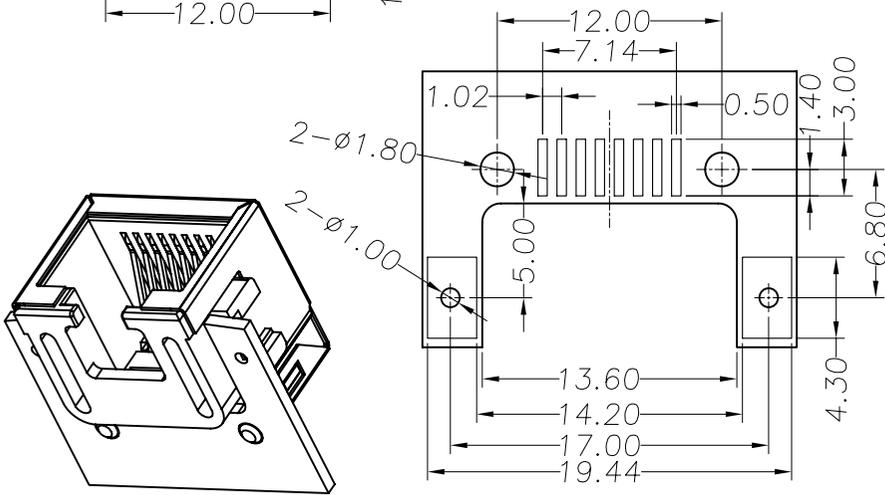
GOLD PLATING (镀金厚度)
1-F U". 2-1.5U". 3-3U". 4-6U".
5-15U". 6-30U". 7-50U"

LOGO (标识):

- 0-W/O LOGO (无标识)
- 1-W/ HAXN (有HAXN标识)
- 2-W/ UL (有UL标识)
- 3-W/ HAXN. UL (有HAXN. UL)

COLOR (颜色):

- 0-BLACK (黑色) .2-GRAY (灰色) .3-WHITE (白色)
- 4-ORANGE (橙色) .5-PINK (粉红色) .6-GREEN (绿色)



PC Board Layout

MM (INCH)		设计 册	日期 册
一般公差 栏		审核 GANBO	日期 06.05.26
MM	±	批准 xushiyong	日期 06.05.26
.0 ± 0.20	±	材料: 材料	
.00 ± 0.15	±	数量: 数量	
.000 ± 0.075	±	表面处理: 表面处理	
角度 ± 0.01°		比例: 比例	
第三角视图			

浙江创都电子科技有限公司

RJ45-0388-CBSMT-SH

SMT-8P8C

图号 △ 图号

料号: 料号

A3 版本

不按比例

共 X 页 第 Y 页